

# AZV99

## PECL/LVDS Oscillator Gain Stage & Buffer with Selectable Enable

### FEATURES

- Green and RoHS Compliant / Lead (Pb) Free Packages Available
- Similar Operation as AZ100LVEL16VT except with **LVDS Outputs**
- Operating Range of 3.0V to 5.5V
- Minimizes External Components
- Selectable Enable Polarity and Threshold (CMOS/TTL or PECL)
- Available in a 2x2 or 3x3mm MLP Package
- S-Parameter (.s2p) and IBIS Model Files Available on Arizona Microtek Website

### PACKAGE AVAILABILITY

PACKAGE	PART NUMBER	MARKING	NOTES
MLP 8 (2x2x0.75) Green / RoHS Compliant / Lead (Pb) Free	AZV99NG	V1G <Date Code>	1,2
MLP 8 (2x2x0.75)	AZV99NA	V9 <Date Code>	1,2
MLP 8 (2x2x0.75) Green / RoHS Compliant / Lead (Pb) Free	AZV99NBG	V8G <Date Code>	1,2
MLP 8 (2x2x0.75) Green / RoHS Compliant / Lead (Pb) Free	AZV99NDG	V2G <Date Code>	1,2
MLP 16 (3x3) Green / RoHS Compliant / Lead (Pb) Free	AZV99LG	AZMG V99 <Date Code>	1,2
TSSOP 8 RoHS Compliant / Lead (Pb) Free	AZV99T+	AZ+ V99	1,2,3
DIE	AZV99XP	N/A	4

1 Add R1 at end of part number for 7 inch (1K parts), R2 for 13 inch (2.5K parts) Tape & Reel.

2 Date code format: "Y" for year followed by "WW" for week.

3 Date Code "YWW" on underside of part.

4 Waffle Pack

### DESCRIPTION

The AZV99 is a specialized oscillator gain stage with LVDS output buffer including an enable. The enable input (EN) allows continuous oscillator operation by only controlling the  $Q_{HG}/\bar{Q}_{HG}$  outputs.

The AZV99 also provides a  $V_{BB}$  and 470 $\Omega$  internal bias resistors from D to  $V_{BB}$  and  $\bar{D}$  to  $V_{BB}$ . The  $V_{BB}$  pin can support 1.5 mA sink/source current. Bypassing  $V_{BB}$  to ground with a 0.01  $\mu$ F capacitor is recommended.

#### MLP 16, 3x3 mm Package (L) or DIE (X)

The MLP 16 and die versions of the AZV99 provide a selectable enable (EN). Enable polarity and threshold can be selected to accommodate either CMOS/TTL or PECL input levels. See the enable truth table for enable function. If enable pull-up is desired in the CMOS/TTL mode, an external  $\leq 20k\Omega$  resistor connecting EN to  $V_{CC}$  will override the on-chip pull-down resistor.

Outputs  $Q/\bar{Q}$  each have a selectable on-chip pull-down current source. See the current source truth table for current source functions. External resistors may also be used to increase pull-down current to a maximum of 25mA (includes internal on-chip current source).

# AZV99

## MLP 8, 2x2 mm Package, NA, NB & ND Options

The MLP 8 NA, NB and ND options of the AZV99 provide a PECL/ECL level enable input ( $\overline{EN}$ ). When the  $\overline{EN}$  input is LOW, the  $\overline{Q}$  and  $Q_{HG}/\overline{Q}_{HG}$  outputs pass data from the inputs. When  $\overline{EN}$  is HIGH, the  $\overline{Q}$  output continues to pass data while the  $Q_{HG}$  output is forced high and the  $\overline{Q}_{HG}$  output is forced low.

Only the  $\overline{Q}$  output operates with a current source (4 mA) to  $V_{EE}$ . This is accomplished by internal bonding of CS-SEL. An external resistor may also be used to increase pull-down current to a maximum of 25mA (includes 4mA on-chip current source).

The AZV99NB and AZV99ND versions operates with a single ended data input (D). The  $\overline{D}$  input is internally bonded directly to the  $V_{BB}$  pin bypassing the 470 $\Omega$  bias resistor.

## TSSOP 8 Package (T), MLP 8 Package, (N)

The TSSOP 8 (T) and MLP 8 (N) versions of the AZV99 provide a CMOS/TTL level enable input (EN). When the EN input is HIGH, the  $\overline{Q}$  and  $Q_{HG}/\overline{Q}_{HG}$  outputs pass data from the inputs. When EN is LOW, the  $\overline{Q}$  output continues to pass data while the  $Q_{HG}$  output is forced high and the  $\overline{Q}_{HG}$  output is forced low.

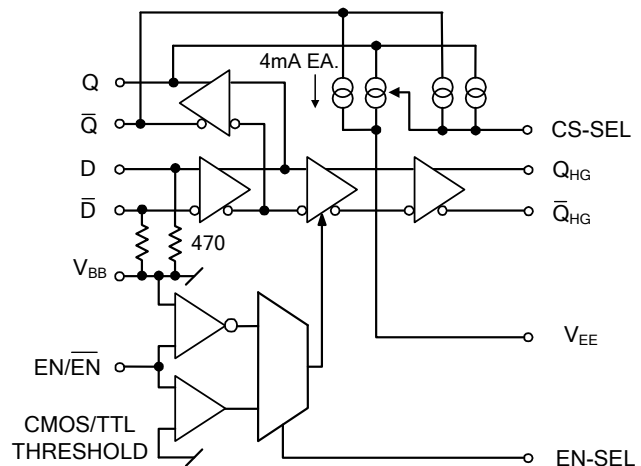
Only the  $\overline{Q}$  output operates with a current source (4 mA) to  $V_{EE}$ . This is accomplished by internal bonding of CS-SEL. An external resistor may also be used to increase pull-down current to a maximum of 25mA (includes 4mA on-chip current source).

The TSSOP 8 (T) and MLP 8 (N) AZV99 operates with a single ended data input (D). The  $\overline{D}$  input is internally bonded directly to the  $V_{BB}$  pin bypassing the 470 $\Omega$  bias resistor.

NOTE: Specifications in the ECL/PECL tables are valid when thermal equilibrium is established.

### PIN DESCRIPTION

PIN	FUNCTION
D/ $\overline{D}$	Data Inputs
Q/ $\overline{Q}$	PECL Data Outputs
$Q_{HG}/\overline{Q}_{HG}$	LVDS Data Outputs
$V_{BB}$	Reference Voltage Output
EN-SEL	Selects Enable Logic
EN/ $\overline{EN}$	Enable Input
CS-SEL	Selects Q and $\overline{Q}$ Current Source Magnitude
$V_{EE}$	Negative Supply
$V_{CC}$	Positive Supply



### ENABLE TRUTH TABLE

EN-SEL	EN/ $\overline{EN}$	Q/ $\overline{Q}$	$Q_{HG}$	$\overline{Q}_{HG}$
NC	PECL Low or NC	Data	Data	Data
NC	PECL High or $V_{CC}$	Data	High	Low
$V_{EE}$ <sup>1</sup>	CMOS/TTL Low, $V_{EE}$ or NC	Data	High	Low
$V_{EE}$ <sup>1</sup>	CMOS/TTL High or $V_{CC}$ <sup>2</sup>	Data	Data	Data

<sup>1</sup> EN-SEL connections must be less than 1 $\Omega$ .

<sup>2</sup> An external  $\leq 20k\Omega$  pull-up resistor between EN and  $V_{CC}$  ensures a High when the EN pin is not driven.

### CURRENT SOURCE TRUTH TABLE

CS-SEL	Q	$\overline{Q}$
NC	4mA typ.	4mA typ.
$V_{EE}$ <sup>1</sup>	8mA typ.	8mA typ.
$V_{CC}$ <sup>1</sup>	0	4mA typ.

<sup>1</sup> CS-SEL connections must be less than 1 $\Omega$ .

**Absolute Maximum Ratings are those values beyond which device life may be impaired.**

Symbol	Characteristic	Rating	Unit
V <sub>CC</sub>	Power Supply	0 to +6.0	Vdc
V <sub>I</sub>	Input Voltage	0 to +6.0	Vdc
V <sub>D/D</sub>	D/ $\bar{D}$ Input Voltage	$\pm 0.75$ with respect to V <sub>BB</sub>	Vdc
I <sub>OUT</sub>	Output Current — Continuous Q/ $\bar{Q}$	25	mA
	— Surge Q/ $\bar{Q}$	50	
	— Continuous Q <sub>HG</sub> / $\bar{Q}$ <sub>HG</sub>	5	
	— Surge Q <sub>HG</sub> / $\bar{Q}$ <sub>HG</sub>	10	
T <sub>A</sub>	Operating Temperature Range	-40 to +85	°C
T <sub>STG</sub>	Storage Temperature Range	-65 to +150	°C

**100K LVPECL DC Characteristics (V<sub>EE</sub> = GND, V<sub>CC</sub> = +3.3V)**

Symbol	Characteristic	-40°C		0°C		25°C		85°C		Unit
		Min	Max	Min	Max	Min	Max	Min	Max	
V <sub>OH</sub>	Output HIGH Voltage <sup>1,2</sup> Q/ $\bar{Q}$	2255	2465	2275	2465	2275	2465	2275	2465	mV
V <sub>OL</sub>	Output LOW Voltage <sup>1,2</sup> Q/ $\bar{Q}$	1375	1745	1400	1680	1400	1680	1400	1680	mV
V <sub>IH</sub>	Input HIGH Voltage									
	D/ $\bar{D}$ <sup>1</sup> , EN (EN-SEL open) <sup>1</sup> EN (EN-SEL tied to V <sub>EE</sub> )	2135 2000	2560 V <sub>CC</sub>	2135 2000	2560 V <sub>CC</sub>	2135 2000	2560 V <sub>CC</sub>	2135 2000	2560 V <sub>CC</sub>	mV
V <sub>IL</sub>	Input LOW Voltage									
	D/ $\bar{D}$ <sup>1</sup> , EN (EN-SEL open) <sup>1</sup> EN (EN-SEL tied to V <sub>EE</sub> )	1400 GND	1825 800	1400 GND	1825 800	1400 GND	1825 800	1400 GND	1825 800	mV
V <sub>BB</sub>	Reference Voltage <sup>1</sup>	1910	2050	1910	2050	1910	2050	1910	2050	mV
I <sub>IL</sub>	Input LOW Current EN <sup>3</sup>	0.5		0.5		0.5		0.5		μA
I <sub>IH</sub>	Input HIGH Current EN <sup>3</sup>		150		150		150		150	μA
I <sub>EE</sub>	Power Supply Current <sup>2</sup>		48		48		48		52	mA

1. Voltage levels vary 1:1 with V<sub>CC</sub>.
2. Specified with CS-SEL open.
3. Specified with EN-SEL open.

**100K PECL DC Characteristics (V<sub>EE</sub> = GND, V<sub>CC</sub> = +5.0V)**

Symbol	Characteristic	-40°C		0°C		25°C		85°C		Unit
		Min	Max	Min	Max	Min	Max	Min	Max	
V <sub>OH</sub>	Output HIGH Voltage <sup>1,2</sup> Q/ $\bar{Q}$	3955	4165	3975	4165	3975	4165	3975	4165	mV
V <sub>OL</sub>	Output LOW Voltage <sup>1,2</sup> Q/ $\bar{Q}$	3075	3445	3100	3380	3100	3380	3100	3380	mV
V <sub>IH</sub>	Input HIGH Voltage									
	D/ $\bar{D}$ <sup>1</sup> , EN (EN-SEL open) <sup>1</sup> EN (EN-SEL tied to V <sub>EE</sub> )	3835 2000	4260 V <sub>CC</sub>	3835 2000	4260 V <sub>CC</sub>	3835 2000	4260 V <sub>CC</sub>	3835 2000	4260 V <sub>CC</sub>	mV
V <sub>IL</sub>	Input LOW Voltage									
	D/ $\bar{D}$ <sup>1</sup> , EN (EN-SEL open) <sup>1</sup> EN (EN-SEL tied to V <sub>EE</sub> )	3100 GND	3525 800	3100 GND	3525 800	3100 GND	3525 800	3100 GND	3525 800	mV
V <sub>BB</sub>	Reference Voltage <sup>1</sup>	3610	3750	3610	3750	3610	3750	3610	3750	mV
I <sub>IL</sub>	Input LOW Current EN <sup>3</sup>	0.5		0.5		0.5		0.5		μA
I <sub>IH</sub>	Input HIGH Current EN <sup>3</sup>		150		150		150		150	μA
I <sub>EE</sub>	Power Supply Current <sup>2</sup>		48		48		48		52	mA

1. Voltage levels vary 1:1 with V<sub>CC</sub>.
2. Specified with CS-SEL open.
3. Specified with EN-SEL open.

**LVDS DC Characteristics for Q<sub>HG</sub>/Q̄<sub>HG</sub> Outputs<sup>1</sup> (V<sub>EE</sub> = GND, V<sub>CC</sub> = +3.0V to +5.5V)**

Symbol	Characteristic	-40°C		0°C		25°C		85°C		Unit
		Min	Max	Min	Max	Min	Max	Min	Max	
V <sub>OH</sub>	Output HIGH Voltage		1600		1600		1600		1600	mV
V <sub>OL</sub>	Output LOW Voltage	900		900		900		900		mV
V <sub>OC</sub>	Output Common Mode Voltage <sup>2</sup>	1125	1375	1125	1375	1125	1375	1125	1375	mV
ΔV <sub>OC</sub>	Change in Common Mode Voltage <sup>3</sup>	-50	50	-50	50	-50	50	-50	50	mV
V <sub>OUT</sub>	Single-Ended Output Swing	250	450	250	450	250	450	250	450	mV
V <sub>DIFF_OUT</sub>	Differential Output Swing	500	900	500	900	500	900	500	900	mV

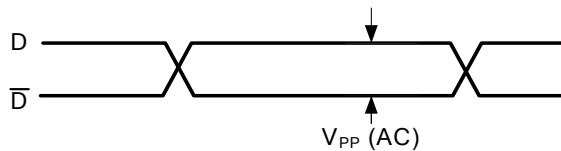
1. Specified with 100Ω resistor connecting Q<sub>HG</sub> and Q̄<sub>HG</sub> together.
2. Common mode voltage is the center voltage between Q<sub>HG</sub> and Q̄<sub>HG</sub> during a steady state.
3. Change in common mode voltage is the difference between common mode voltages at opposite binary states.

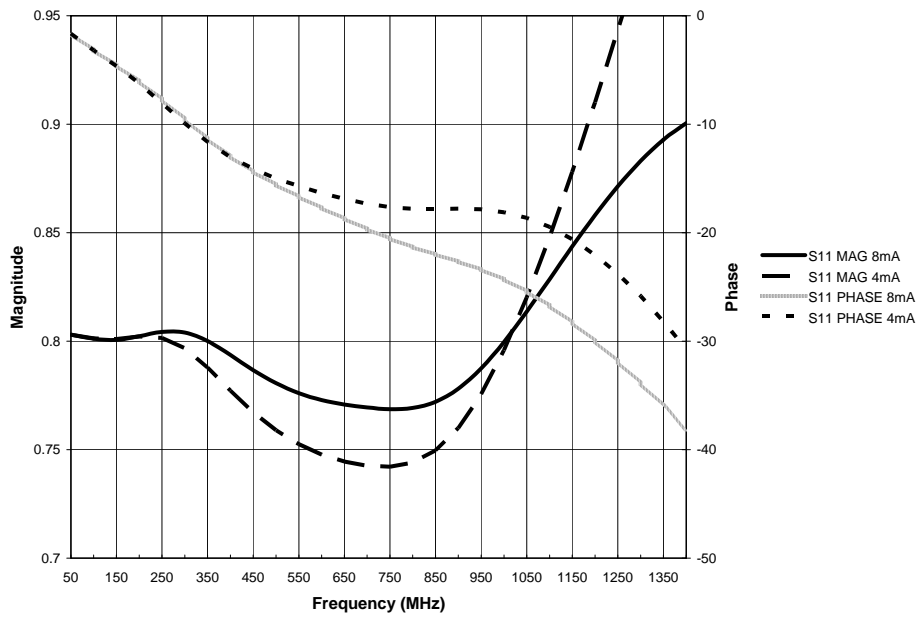
**AC Characteristics (V<sub>EE</sub> = GND, V<sub>CC</sub> = +3.0V to +5.5V)**

Symbol	Characteristic	-40°C			0°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
t <sub>PLH</sub> / t <sub>PHL</sub>	Propagation Delay D to Q/Q̄ Outputs <sup>1</sup> (SE)			400			400			400			430	ps
	D to Q <sub>HG</sub> /Q̄ <sub>HG</sub> Outputs <sup>2</sup> (SE)			550			550			550			630	
t <sub>SKEW</sub>	Duty Cycle Skew Q/Q̄ <sup>3</sup> (SE)		5	20		5	20		5	20		5	20	ps
V <sub>PP</sub> (AC)	Differential Input Swing <sup>4</sup>	80		1000	80		1000	80		1000	80		1000	mV
t <sub>r</sub> / t <sub>f</sub>	Output Rise/Fall Times (20% - 80%)			260			260			260			260	ps
	Q/Q̄ <sup>1</sup> Q <sub>HG</sub> /Q̄ <sub>HG</sub> <sup>2</sup>	100		280	100		280	100		280	100		280	

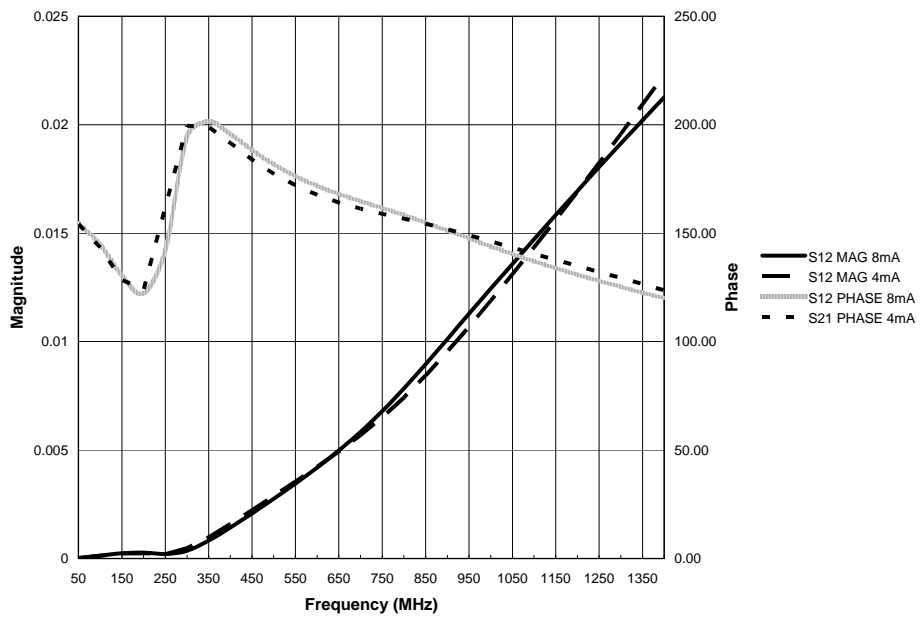
1. Specified with CS-SEL connected to V<sub>EE</sub> and Q/Q̄ with AC coupled 50Ω loads.
2. Specified with 100Ω resistor connecting Q<sub>HG</sub> and Q̄<sub>HG</sub> together.
3. Duty cycle skew is the difference between a t<sub>PLH</sub> and t<sub>PHL</sub> propagation delay through a device.
4. The peak-to-peak differential input swing is the range for which AC parameters guaranteed. V<sub>D</sub> and V<sub>D</sub> must remain within the range of ±750 mV with respect to V<sub>BB</sub>.

**AC PP INPUT**

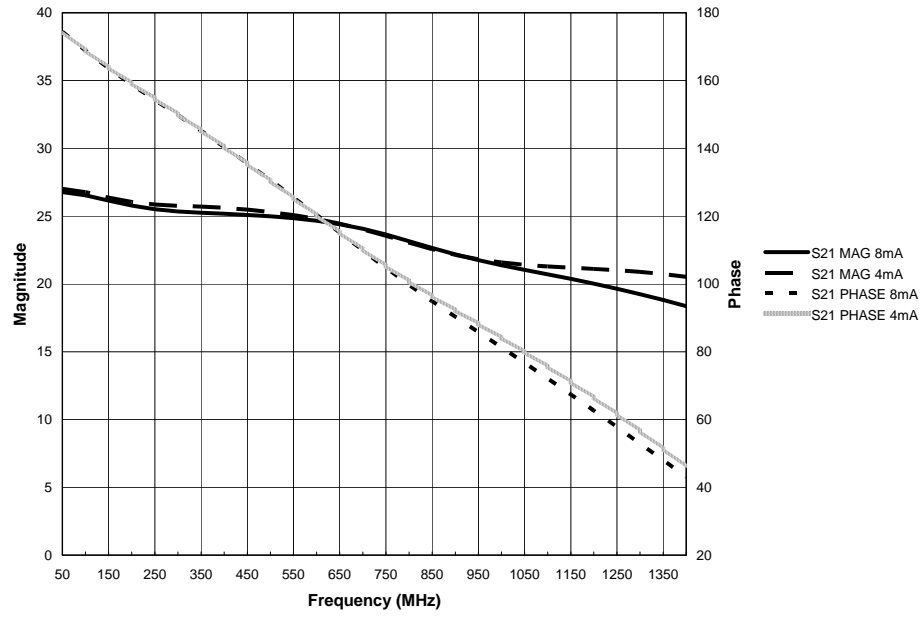




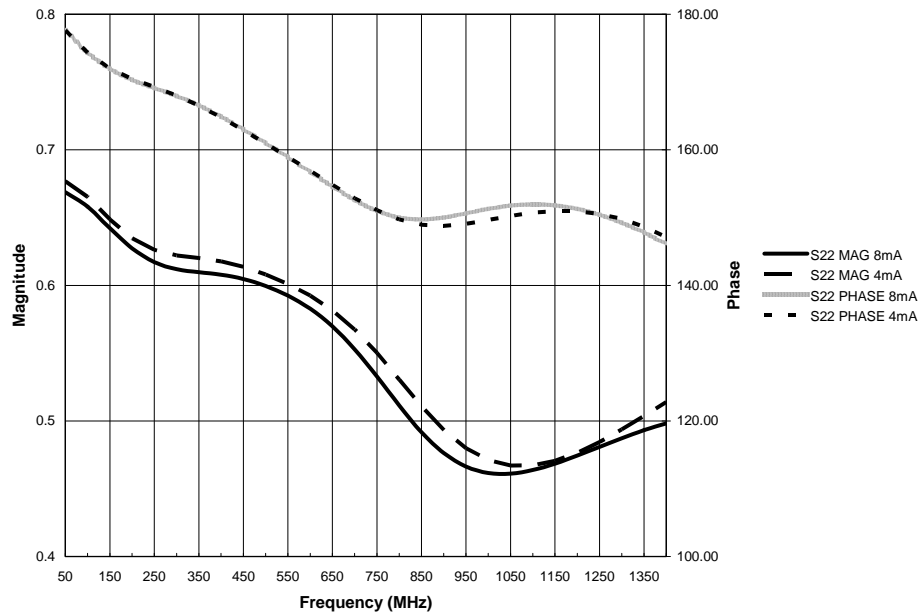
**S11, D to Q, 50 Ω AC load on Q**



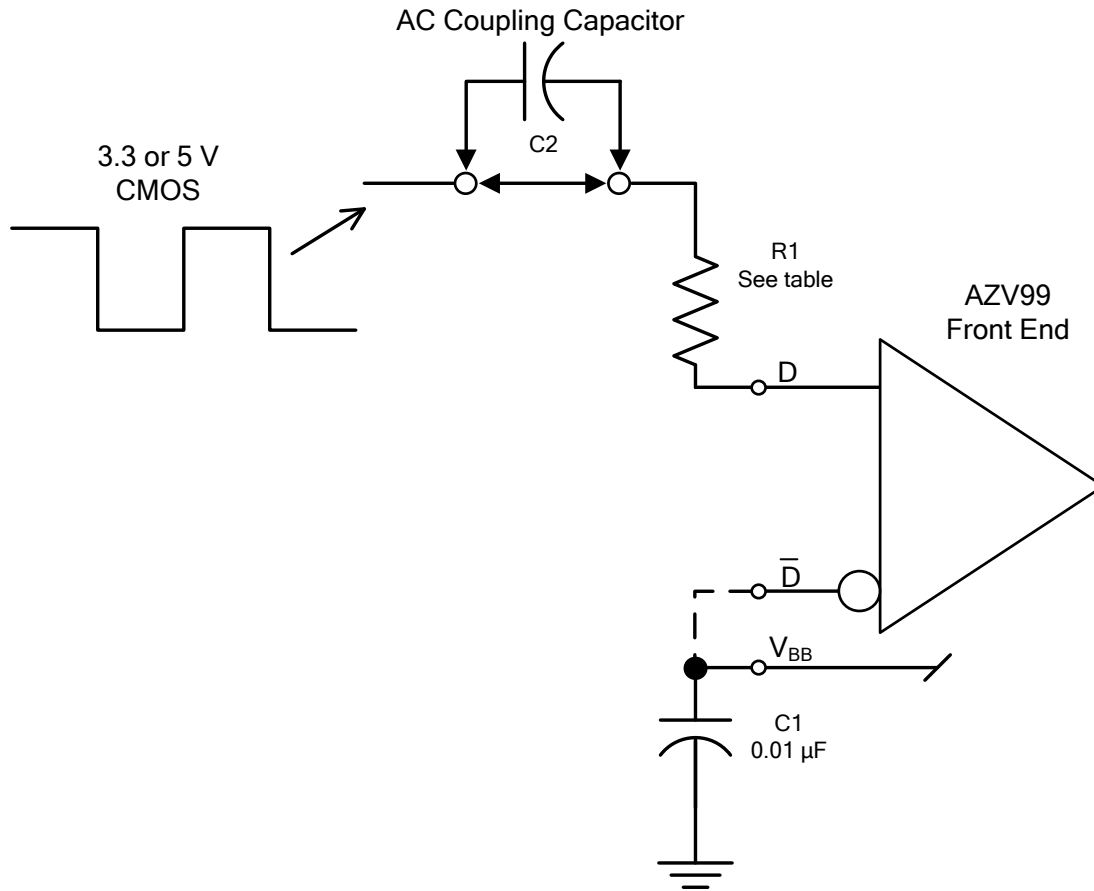
**S12, D to Q, 50 Ω AC load on Q**



**S21, D to Q, 50 Ω AC load on Q**



**S22, D to Q, 50 Ω AC load on Q**



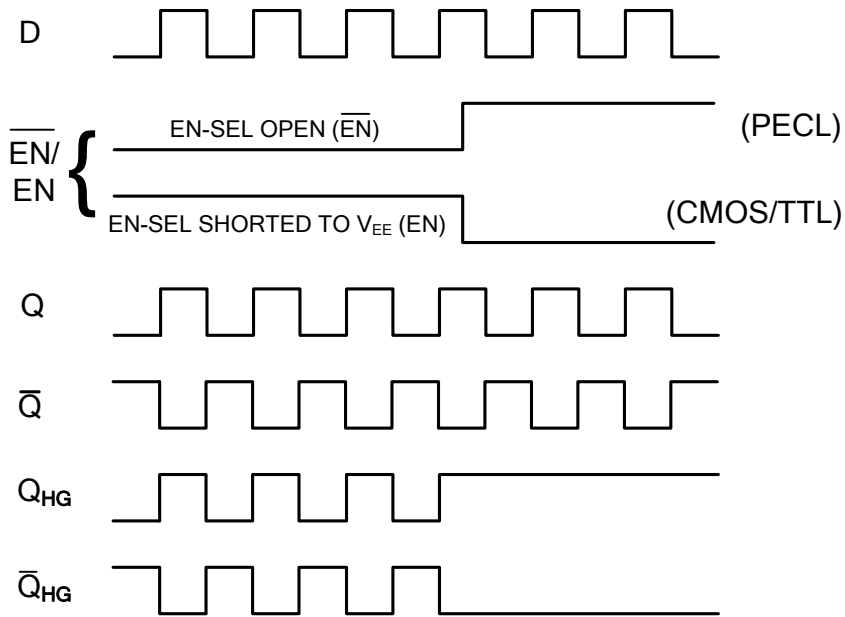
### Application Circuit for CMOS Inputs

Input Type	R1 <sup>1</sup>	
	AC Coupled (C2 in circuit)	DC Coupled (C2 shorted)
3.3 V CMOS	1.1 kΩ	2.0 kΩ
5 V CMOS	1.6 kΩ	3.3 kΩ

<sup>1</sup> R1 should be chosen so that the input swing on the D input with respect to  $\bar{D}$  is in the range of  $\pm 80$  to  $\pm 1000$  mV, per the AC Characteristics table and the D input is  $< \pm 750$  mV with respect to  $V_{BB}$ .

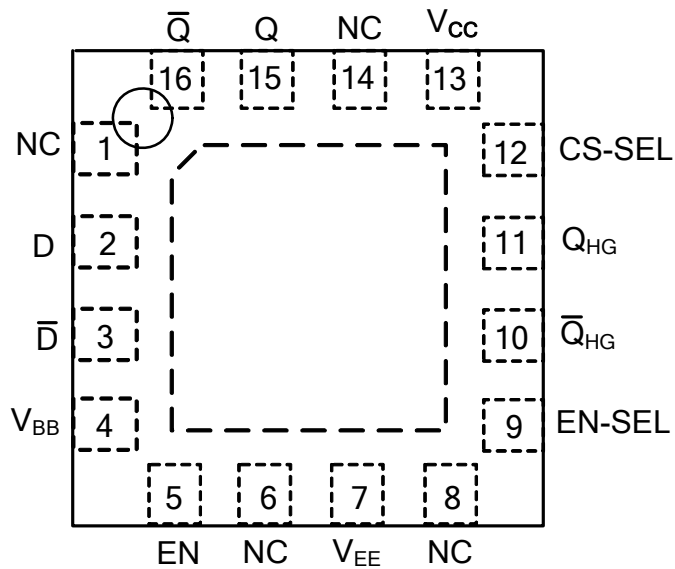
### Recommended Component Values for CMOS Single Ended Inputs

**TIMING DIAGRAM**



**PINOUT FOR AZV99L**

MLP 16, 3x3mm  
AZV99L

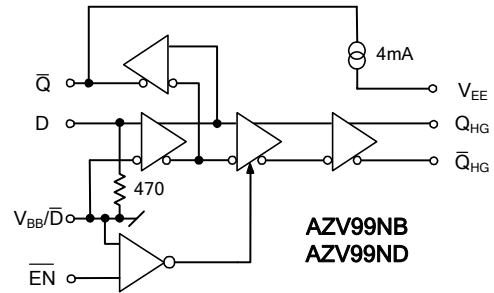
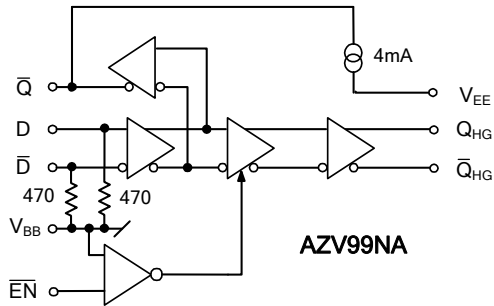


**TOP VIEW**

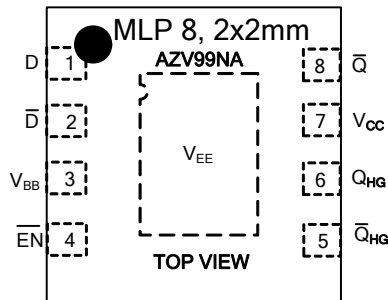
Bottom Center Pad may be left open or tied to V<sub>EE</sub>



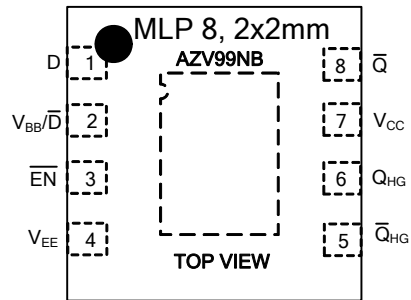
**LOGIC DIAGRAMS AND PINOUTS FOR  
AZV99NA, AZV99NB, AZV99ND**



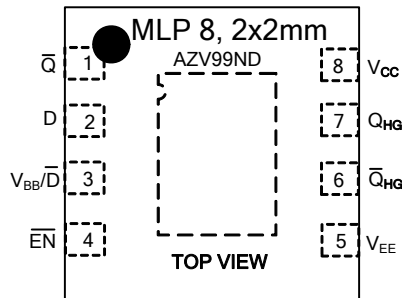
**EN operation follows PECL functionality. See the  
Timing Diagram.**



**Bottom Center Pad is the  $V_{EE}$   
return.**

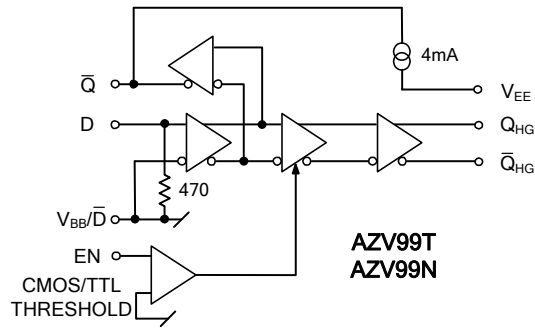


**Bottom Center Pad may be left open  
or tied to  $V_{EE}$ . Pin 4 is the  $V_{EE}$   
return.**

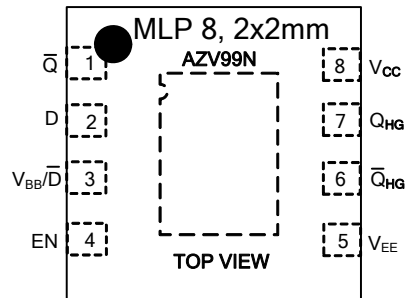
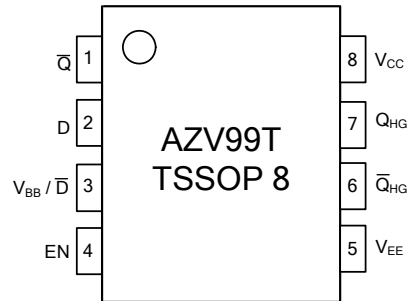


**Bottom Center Pad may be left open  
or tied to  $V_{EE}$ . Pin 5 is the  $V_{EE}$   
return.**

**LOGIC DIAGRAM AND PINOUTS FOR  
AZV99T, AZV99N**



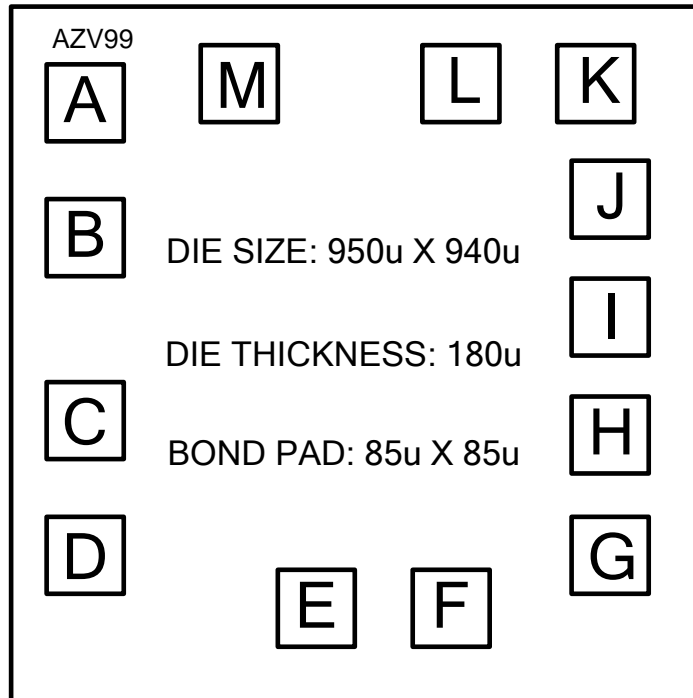
**EN follows CMOS/TTL functionality. See the Timing Diagram.**



**Bottom Center Pad may be left open or tied to V<sub>EE</sub>. Pin 5 is the V<sub>EE</sub> return.**

**DIE PAD COORDINATES**

AZV99 DIE:

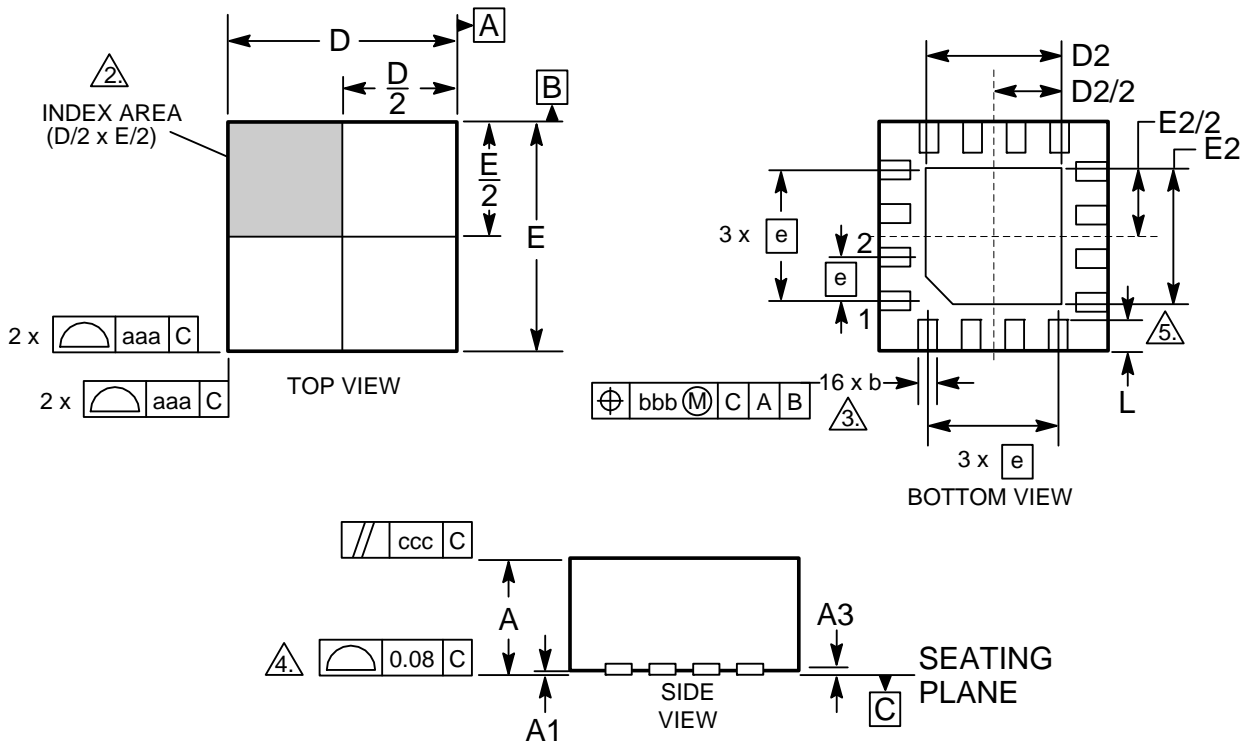


**PAD COORDINATES<sup>1</sup>**

NAME	PAD DESIGNATION	PAD CENTERS	
		X(Microns)	Y(Microns)
A	D	-342.5	312.5
B	$\bar{D}$	-342.5	144.5
C	$V_{BB}$	-342.5	-87.0
D	$EN/\bar{EN}$	-342.5	-255.0
E	$V_{EE}$	-33.5	-312.5
F	NC	126.5	-312.5
G	EN-SEL	312.5	-248.5
H	$\bar{Q}_{HG}$	312.5	-98.5
I	$Q_{HG}$	312.5	51.5
J	CS-SEL	312.5	201.5
K	$V_{CC}$	302.5	342.5
L	Q	142.5	342.5
M	$\bar{Q}$	-140.5	342.5

1. 0, 0 is center of die.

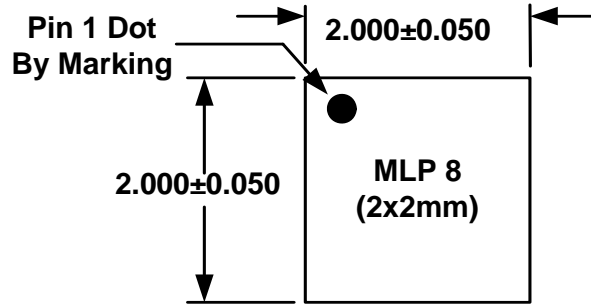
**PACKAGE DIAGRAM  
MLP 16**



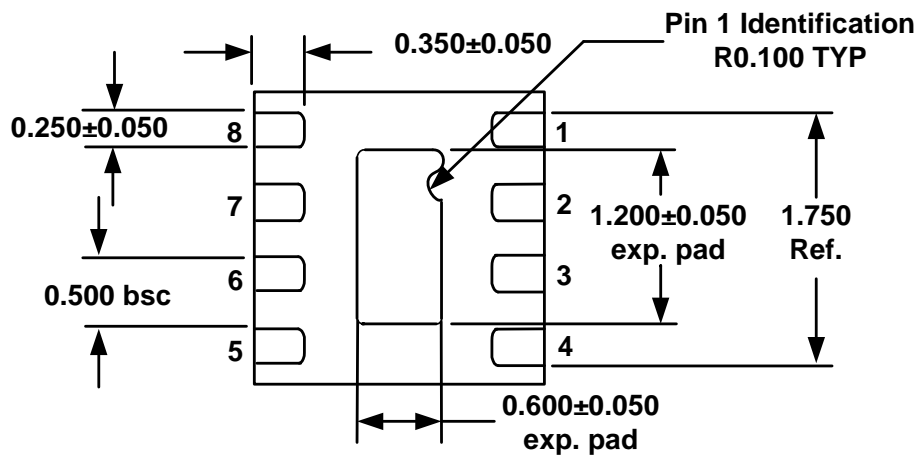
- NOTES:
1. DIMENSIONING AND TOLERANCING CONFORM TO ASME T14-1994.
  2. THE TERMINAL #1 AND PAD NUMBERING CONVENTION SHALL CONFORM TO JESD 95-1 SPP-012.
  3. DIMENSION  $b$  APPLIES TO METALLIZED PAD AND IS MEASURED BETWEEN 0.25 AND 0.30 mm FROM PAD TIP.
  4. COPLANARITY APPLIES TO THE EXPOSED PADS AS WELL AS THE TERMINALS.
  5. INSIDE CORNERS OF METALLIZED PAD MAY BE SQUARE OR ROUNDED

DIM	MILLIMETERS	
	MIN	MAX
A	0.80	1.00
A1	0.00	0.05
A3	0.25 REF	
b	0.18	0.30
D	2.90	3.10
D2	0.25	1.95
E	2.90	3.10
E2	0.25	1.95
e	0.50 BSC	
L	0.30	0.50
aaa	0.25	
bbb	0.10	
ccc	0.10	

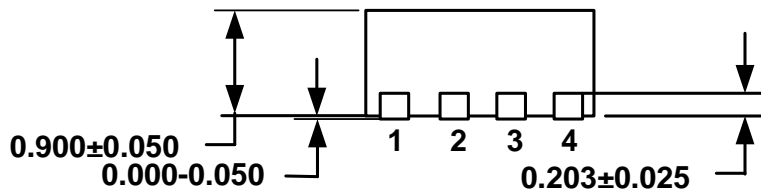
**PACKAGE DIAGRAM**  
**MLP 8 2x2mm**



TOP VIEW



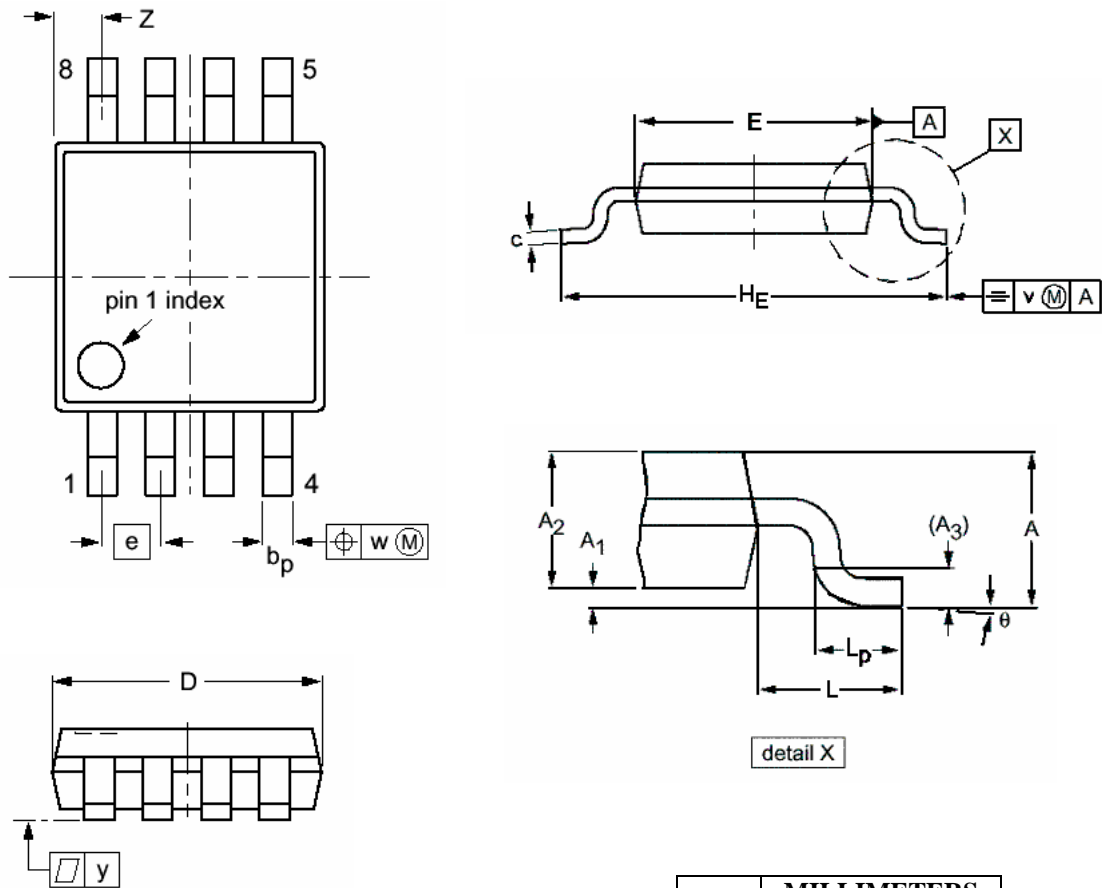
BOTTOM VIEW



SIDE VIEW

**Note: All dimensions are in mm**

**PACKAGE DIAGRAM  
TSSOP 8**



- NOTES:
1. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSION.
  2. MAXIMUM MOLD PROTRUSION FOR D IS 0.15mm.
  3. MAXIMUM MOLD PROTRUSION FOR E IS 0.25mm.

DIM	MILLIMETERS	
	MIN	MAX
A		1.10
A <sub>1</sub>	0.05	0.15
A <sub>2</sub>	0.80	0.95
A <sub>3</sub>	0.25	
b <sub>p</sub>	0.25	0.45
c	0.15	0.28
D	2.90	3.10
E	2.90	3.10
e	0.65	
H <sub>E</sub>	4.70	5.10
L	0.94	
L <sub>p</sub>	0.40	0.70
v	0.10	
w	0.10	
y	0.10	
Z	0.35	0.70
$\theta$	0°	6°

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